Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

1. Listing of Claims:

1. (Original) A circuit board assembly comprising:

a circuit board;

an electronic component;

a first structure coupling the electronic component to the circuit board and retaining the electronic component relative to the circuit board at a selected one of a plurality of positions in both directions along a first axis perpendicular to the circuit board, wherein the first structure is movably coupled to one of the electronic component and the circuit board for movement in a direction perpendicular to the first axis at least prior to being coupled to the other of the electronic component and the circuit board.

2. (Original) The circuit board assembly of Claim 1, wherein the first structure is movably coupled to the electronic component.

3. (Currently Amended) The circuit board assembly of Claim 1 including:

a first threaded portion coupled to said other of the electronic component and the circuit board;

a second structure movably coupled to said one of the electronic component and the circuit board to move in at least one direction perpendicular to the first axis, the second structure having a second threaded portion, wherein the first structure has a third threaded portion and wherein the third threaded portion is screwed to the ~~a~~ first threaded portion and the second threaded portion.

4. (Original) The circuit board assembly of Claim 3, wherein the second structure is coupled to said one of the electronic component and the circuit board against complete rotation about the first axis.

5. (Original) The circuit board assembly of Claim 4, wherein the second structure is keyed to said one of electronic component and the circuit board against complete rotation about the first axis.

6. (Original) The circuit board assembly of Claim 5, wherein the second structure includes at least one projection received within a corresponding opening formed in the electronic component to prevent complete rotation of the second structure about the first axis.

7. (Original) The circuit board assembly of Claim 3, wherein the second structure is releasably coupled to the electronic component.

8. (Original) The circuit board assembly of Claim 1 including a second structure coupling the electronic component to the circuit board and retaining the electronic component relative to the circuit board at a selected one of a plurality of positions in both directions along a second axis non-parallel to the circuit board, wherein the second structure is movably coupled to one of the electronic component and the circuit board for movement in a direction perpendicular to the second axis at least prior to being coupled to the other of the electronic component and the circuit board.

9. (Original) The circuit board assembly of Claim 8, wherein the second structure is movably coupled to the electronic component.

10. (Previously Presented) The circuit board assembly of Claim 8 including:

a first threaded portion coupled to said other of the electronic component and the circuit board;

a second threaded portion coupled to said one of the electronic component and the circuit board;

a third structure movably coupled to said one of the electronic component and the circuit board to move in at least one direction perpendicular to the first axis, the third structure having a third threaded portion, wherein the third threaded portion is screwed to the first threaded portion and the second threaded portion;

a fourth threaded portion coupled to said other of the electronic component and the circuit board;

a fifth threaded portion coupled to said one of the electronic component and the circuit board; and

a fourth structure movably coupled to said one of the electronic component and the circuit board to move in at least one direction perpendicular to the second axis, the fourth structure having a sixth threaded portion and wherein the sixth threaded portion is screwed to the fourth threaded portion and the fifth threaded portion.

11. (Currently Amended) The circuit board assembly of Claim 1, wherein the electronic component includes a post and wherein the first structure consists of a single integral unitary structure and extends within the post.

12. (Original) The circuit board assembly of Claim 1, wherein the electronic component includes a heat sink.

13. (Original) The circuit board assembly of Claim 1 including a first connector portion coupled to the circuit board, wherein the electronic component includes:

a processor assembly;

a heat sink coupled to the processor assembly; and

a second connector portion coupled to the processor assembly and releasably connected to the first connector portion.

14. (Original) The circuit board assembly of Claim 13 including a power supply configured to supply power to the processor assembly and having a mass cantilevered relative to the circuit board, wherein the first structure supports the cantilevered mass of the power supply.

15. (Original) The circuit board assembly of Claim 13 including:

a first threaded portion coupled to said other of the electronic component and the circuit board;

a second structure movably coupled to said one of the electronic component and the circuit board to move in at least one direction perpendicular to the first axis, the second structure having a second threaded portion, wherein the first structure has a third threaded portion and wherein the third threaded portion is screwed to the first threaded portion and the second threaded portion.

16. (Original) The circuit board assembly of Claim 13 including:

a second structure coupling the electronic component to the circuit board and retaining the electronic component relative to the circuit board at a selected one of a plurality of positions in both directions along a second axis perpendicular to the circuit board, wherein the second structure is movably coupled to said one of the electronic component and the circuit board for movement in a direction perpendicular to the second axis at least prior to being coupled to the other of the electronic component and the circuit board and wherein the first structure and the second structure extend on a first side of processor assembly; and

a first plurality of mounting members coupling the circuit board and the heat sink on a second opposite side of the processor assembly.

17. (Original) The circuit board assembly of Claim 16 including:

a second plurality of mounting members coupling the circuit board and the heat sink between the processor assembly and the first and second structure.

18. (Original) The circuit board assembly of Claim 17, wherein the first plurality of mounting members and the second plurality of mounting members load the first connector portion into connection with the second connector portion.

19. (Original) The circuit board assembly of Claim 1, wherein the first structure is movable in a direction perpendicular to the first axis by a distance of at least 0.3 mm.

20. (Original) The circuit board assembly of Claim 19, wherein the first structure is movable in a direction perpendicular to the first axis by a distance no greater than 0.9 mm.

21. (Original) The circuit board assembly of Claim 1, wherein the first structure includes a first surface obliquely extending relative to the first axis and configured to engage

a second surface coupled to the other of the electronic component and the circuit board while the first structure is moved along the first axis to cause movement of the first structure in the direction perpendicular to the first axis.

22. (Original) The circuit board assembly of Claim 1, wherein the first structure includes a first surface and wherein the assembly further includes a second structure coupled to the other of the electronic component and the circuit board, the second structure having a second surface configured to engage the first surface as the first structure and the second structure are moved towards one another along the first axis, wherein at least one of the first surface and the second surface extends oblique relative to the first axis to cause movement of the first structure in the direction perpendicular to the first axis.

23. (Original) An electronic component mounting unit for use with a circuit board, the mounting unit comprising:

an electronic component;

a first structure coupled to the electronic component and configured to be releasably coupled to the circuit board to retain the electronic component relative to the circuit board at selected one of a plurality of positions in both directions along an axis perpendicular to the circuit board, wherein the structure is movably coupled to the electronic component for movement in a direction perpendicular to the axis at least prior to being coupled to the circuit board.

24. (Original) The unit of Claim 23, wherein an electronic component includes a heat sink.

25. (Original) The unit of Claim 23, wherein the circuit board includes a first connector portion and wherein the electronic component includes:

a processor assembly;

a heat sink coupled to the processor assembly;

a second connector portion coupled to the processor assembly and configured to be releasably connected to the first connector portion.

26. (Original) The unit of Claim 25, wherein the first structure is configured to couple the electronic component to the circuit board on a first side of the processor assembly and wherein the unit further includes:

a first plurality of mounting members configured to couple the circuit board to the heat sink on a second opposite side of the processor assembly; and

a second plurality of mounting members configured to couple the circuit board to the heat sink between the processor assembly and the first structure.

27. (Original) The unit of Claim 26, wherein the heat sink includes a post and wherein the first structure extends within the post.

28. (Original) The unit of Claim 27, wherein the circuit board includes a first threaded portion and wherein the unit includes:

a second structure movably coupled to the electronic component to move in at least one direction perpendicular to the axis, the second structure having a second threaded portion, wherein the first structure has a third threaded portion and wherein the third threaded portion is screwed to the second threaded portion and is configured to be screwed to the first threaded portion.

29. (Original) The unit of Claim 25, wherein the circuit board includes a first threaded portion and wherein the unit includes:

a second structure movably coupled to the electronic component to move in at least one direction perpendicular to the axis, the second structure having a second threaded portion, wherein the first structure has a third threaded portion and wherein the third threaded portion is screwed to the second threaded portion and is configured to be screwed to the first threaded portion.

30. (Original) The unit of Claim 23, wherein the first structure is movable in a direction perpendicular to the first axis by a distance of at least 0.3 mm.

31. (Original) The unit of Claim 30, wherein the first structure is movable in a direction perpendicular to the first axis by a distance no greater than 0.9 mm.

32. (Currently Amended) The unit of Claim 23, wherein the first structure includes a surface extending oblique relative to the axis and configured to engage a surface coupled to the circuit board during movement of the structure along the axis so as to also cause ~~movement~~ translation of the first structure in the direction perpendicular to the axis relative to the electronic component.

33. (Canceled)

34. (Canceled)

35. (Canceled)

36. (Canceled)

37. (Canceled)

38. (Canceled)

39. (Canceled)

40. (Canceled)

41. (Canceled)

42. (Canceled)

43. (Canceled)

44. (Previously Presented) A circuit board assembly comprising:

an electronic component;

a circuit board; and

means for retaining the electronic component relative to the circuit board in a selected one of a plurality of positions in both directions along an axis while permitting movement of at least one of the electronic component and the circuit board in at least one direction perpendicular to the axis.

45. (Canceled)

46. (Canceled)

47. (Canceled)

48. (Canceled)

49. (Canceled)

50. (Previously Presented) A circuit board assembly comprising:
a circuit board;

a first connector portion coupled to the circuit board;

an electronic component comprising:

a processor assembly;

a heat sink coupled to the processor assembly; and

a second connector portion coupled to the processor assembly and releasably connected to the first connector portion; and

a first structure coupling the electronic component to the circuit board and retaining the electronic component relative to the circuit board at a selected one of a plurality of positions in both directions along a first axis perpendicular to the circuit board, wherein the first structure is movably coupled to one of the electronic component and the circuit board for movement in a direction perpendicular to the first axis at least prior to being coupled to the other of the electronic component and the circuit board.

51. (Previously Presented) A circuit board assembly comprising:
a circuit board;

an electronic component;

a first structure coupling the electronic component to the circuit board and retaining the electronic component relative to the circuit board at a selected one of a plurality of positions in both directions along a first axis perpendicular to the circuit board, wherein the first structure is movably coupled to one of the electronic component and the circuit board for movement in a direction perpendicular to the first axis at least prior to being coupled to the other of the electronic component and the circuit board;

a second structure coupling the electronic component to the circuit board and retaining the electronic component relative to the circuit board at a selected one of a plurality of positions in both directions along a second axis non-parallel to the circuit board, wherein the second structure is movably coupled to one of the electronic component and the circuit board for movement in a direction perpendicular to the second axis at least prior to being coupled to the other of the electronic component and the circuit board;

a first threaded portion coupled to said other of the electronic component and the circuit board;

a second threaded portion coupled to said one of the electronic component and the circuit board;

a third structure movably coupled to said one of the electronic component and the circuit board to move in at least one direction perpendicular to the first axis, the third structure having a third threaded portion, wherein the third threaded portion is screwed to the first threaded portion and the second threaded portion;

a fourth threaded portion coupled to said other of the electronic component and the circuit board;

a fifth threaded portion coupled to said one of the electronic component and the circuit board; and a fourth structure movably coupled to said one of the electronic component and the circuit board to move in at least one direction perpendicular to the second axis, the fourth structure having a sixth threaded portion and wherein the sixth threaded portion is screwed to the fourth threaded portion and the fifth threaded portion.

52. (Currently Amended) An electronic component mounting unit for use with a circuit board, the mounting unit comprising:

an electronic component;

a first structure coupled to the electronic component and configured to be releasably coupled to the circuit board to retain the electronic component relative to the circuit board at selected one of a plurality of positions in both directions along an axis perpendicular to the circuit board, wherein the structure is movably coupled to the electronic component for movement in a direction perpendicular to the axis at least prior to being coupled to the circuit board, wherein the first structure includes a surface extending oblique relative to the axis and configured to engage a surface coupled to the circuit board during movement of the structure along the axis so as to also cause ~~movement~~ translation of the first structure in the direction perpendicular to the axis relative to the electronic component.

53. (New) The circuit board assembly of claim 1, wherein the first structure consists of a single integral unitary structure.

54. (New) The unit of claim 23, wherein the first structure consists of a single integral unitary structure.

55. (New) The circuit board assembly of Claim 13 including a power supply configured to supply power to the processor assembly and having a mass cantilevered relative to the circuit board, wherein the first structure supports the cantilevered mass of the power supply.

56. (New) The circuit board assembly of Claim 51 including:

a first threaded portion coupled to said other of the electronic component and the circuit board;

a second structure movably coupled to said one of the electronic component and the circuit board to move in at least one direction perpendicular to the first axis, the second structure having a second threaded portion, wherein the first structure has a third threaded portion and wherein the third threaded portion is screwed to the first threaded portion and the second threaded portion.

57. (New) The circuit board assembly of Claim 51 including:

a second structure coupling the electronic component to the circuit board and retaining the electronic component relative to the circuit board at a selected one of a plurality of positions in both directions along a second axis perpendicular to the circuit board, wherein the second structure is movably coupled to said one of the electronic component and the circuit board for movement in a direction perpendicular to the second axis at least prior to being coupled to the other of the electronic component and the circuit board and wherein the first structure and the second structure extend on a first side of processor assembly; and

a first plurality of mounting members coupling the circuit board and the heat sink on a second opposite side of the processor assembly.

58. (New) The circuit board assembly of Claim 51 including:

a second plurality of mounting members coupling the circuit board and the heat sink between the processor assembly and the first and second structure.

59. (New) The circuit board assembly of Claim 51, wherein the first plurality of mounting members and the second plurality of mounting members load the first connector portion into connection with the second connector portion.